IAC-IMX6-CM V3.01
Core Board Hardware Manual

Version： 2.0
2022.01

QIYANG INTELLIGENTTECHNOLOGY Co., Ltd

Catalogue

Notice: This manual introduces the hardware interface of the mainboard

I. Preface

1.1 Company Profile

Zhejiang Qiyang Intelligent Technology Co., Ltd. Was estimated in Hangzhou in 2007. It is a National High-tech Enterprise focusing on the development, production and sales of ARM embedded products. More than 10 years of accumulation and precipitation have successfully constructed a service chain from product development to mass production.

As the core of the company, Qiyang R&D team is composed of more than 30 embedded engineers, who committed to providing users with easy-to-use embedded hardware, software tools and customized product solutions. Our products and solutions have been widely used in industrial control, Internet of Things, new retail, medical, electricity, environmental monitoring, charging piles and other fields.

The production base established in Zhuji provides a strong guarantee for Qiyang. It covers a over 5,000 square meters area also has 2 SMT production lines, and has passed and strictly followed the ISO9001 quality management system certification to guide production. With the strong production strength, the annual output can reach 1 million sets, ensuring the delivery time and solving the worries of users.

Qiyang has a complete sales market network, professional sales and after-sales team providing users with a full range of technical support and services. The business has spread to more than 120 countries and regions, and has successfully helped more than 2,000 users to quickly and efficiently bring products to the market.

The combination and extension of R&D, production capacity and market has laid a solid foundation for Qiyang to become a professional and global supplier of embedded software and hardware.

We offer:

Multi-platform software/hardware products

NXP, Rockchip, MTK, Renesas, TI, Atmel, Cirrus Logic and other multi-platform ARM development boards/core boards/industrial control boards and peripheral hardware products, as well as supporting tools and software resources to support users' rapid

secondary development.

Customized service

Give full play to the accumulation of technology on the ARM platform, Linux, Android, and Ubuntu operating systems to provide users with customized embedded product services (OEM/ODM).

Thank you for using Qiyang Intelligent products. We will spare no effort on providing you with technical assistance! Wish you success in your work!

1.2 Suggestion for Using IAC-IMX6-CM V3.01 Core board

1. Please read the instructions firstly, before using the single board computer;
2. Before using, please check the packing list and see whether there is a missing file in the CD;
3. Please understand the basic structure and composition of ***IAC-IMX6-CM V3.01*** core board, including the hardware resource allocation etc.;
4. If you need to develop on Android system and burn program into the development board, in addition to this document, we also suggest reading another document ***IAC-IMX6-Kit Android User Manual;***
5. ***IAC-IMX6-CM V3.01*** core board accept batch order.

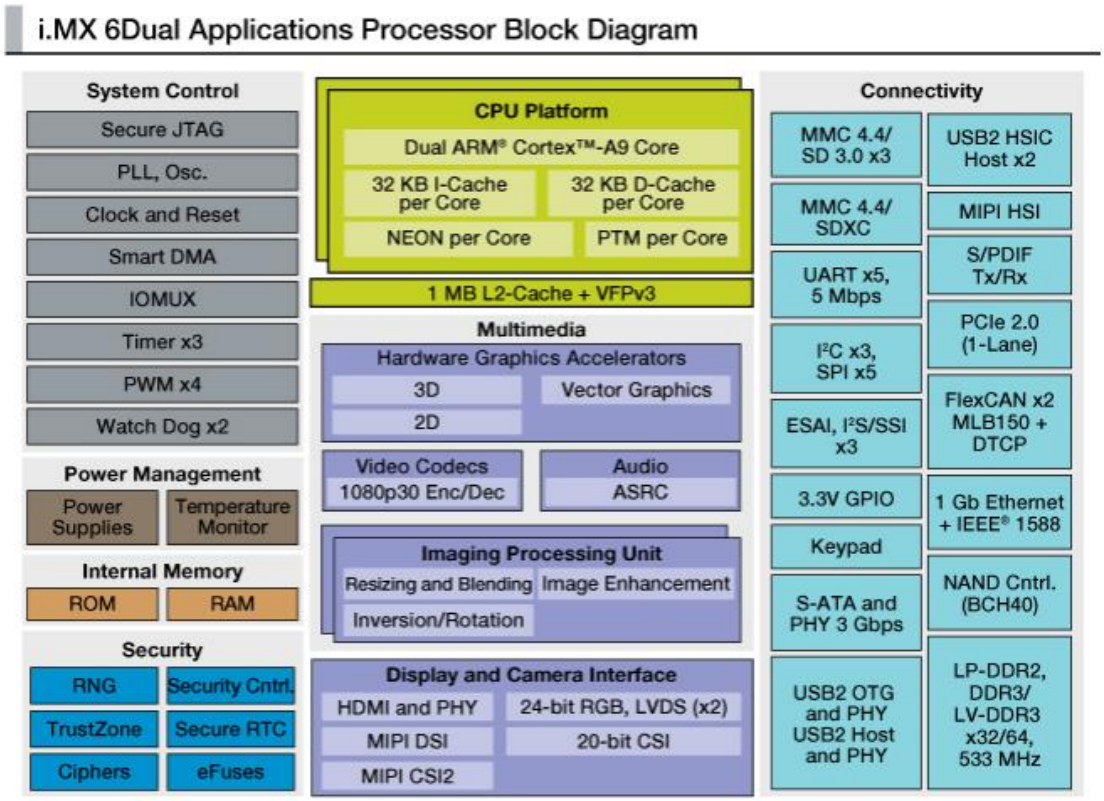
Ⅱ.Product Introduction

2.1 Chipset Introduction

IAC-IMX6-CM V3.01 Core Board, it adopts Freescale i.MX6 processor, Cortex-A9 core with 1G Hz and can be compatible with solo/dual /quad micro processor for upgrading. This mainboard is with standard i.MX6 Dual Core:

The i.MX 6Dual family provides dual cores running up to 1.0 GHz with 1 MB of L2 cache and 64-bit DDR3 or 2-ch., 32-
bit LPDDR2 support. Integrated FlexCAN, MLB bus, HD grade NEON SIMD Media Accelerator, Triple Play 3D/2D/VG Accelerator, 1080P video codec,PCI Express® and S ATA2 provide excellent connectivity, while integration of LVDS, MIPI display port, MIPI ca mera port and HDMI v1.4, the i.MX 6Dual provides a scalable solution for consumer, auto motive and industrial applications.

Function diagram is as shown:



Picture 1

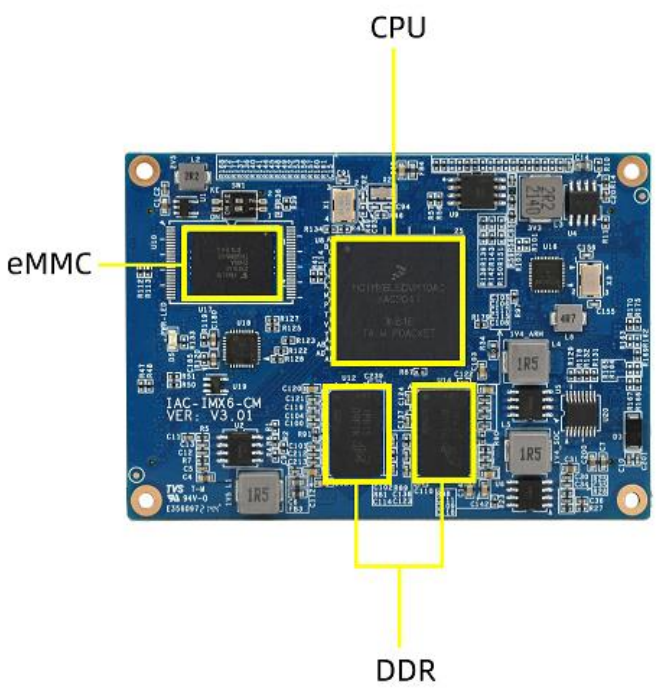
◆ARM® Cortex™-A9, 1.0 GHz, compatible with solo/dual/quad core;
◆1MB L2 Cache,32 KB instruction and data caches, NEON SIMD Media Accelerator;
◆2D/3D/VG Accelerator,1080P h.264 video hardware codec, support dual 720P video encoding;
◆1x 20-bit parallel, MIPI-CSI2 (4-channel), three simultaneous inputs;
◆2-ch HOST USB HSIC, 1-ch OTG and 1-ch HOST USB integrated PHY;
◆1 industrial gigabit Ethernet MAC(10/100/1000MHZ);
◆2-ch CAN ports, each channel can up to 1 Mbps, support CAN2.0;
◆3 SD/MMC 4.4 and 1 SDXC;
◆5 SPI, 5 UART, 3 I2C, 4 PWM;
◆Integrated MIPI-HSI interface, 1-ch PCIe2.0 interface;
◆Dual LVDS interface, support resolution up to 2048*1536;
◆Freescale PF100 PMU;
◆High Assurance Boot, cryptographic cipher engines, random number generator, and tamper detection

2.2. IAC-IMX6-CM V3.01 Core Board

Core Board Configuration	**CPU PN#**	**MCIMX6D5EYM10AD**
	CPU	Freescale i.MX6D processor, ARM® Cortex™-A9 core, 1.0 GHz, compatible with solo-core/dual-core/quad-core
	GPU	2D+3D (3 GPUs), 176 Mtri/s
	VPU	2D/3D/VG Accelerator,1080P h.264 video hardware codec, support dual 720P video encoding;
	RAM	1GB DDR3 (Std.) (*2GB Opt.)
	Flash	4GB EMMCFlash (Std.) (*8GB,16GB,32GB,64GB Opt.)
	Power Input	DC 5V
Electrical Specification	Size	86 mmx 60mmx 1.5mm
	Connector	Board To Board Receptacle
	Pins' Pitch	0.8mm
	Pin Numbers	300*PIN
	Craft	8-Layer
	Material	High TG material,
Connector	Display	Support LCD RGB (*Several PINs can be multiplexed for other signals)
		Support 1*LVDS (Dual Channel), Support resolution up to 2048*1536
		Support MIPI-DSI (Dual Channel)
		Support 1*HDMI1.4 , HD video and audio output
	UART	Total:5*UART, including 1*Debug UART(*Several PINs can be multiplexed for other signals)
	USB	1*USB OTG

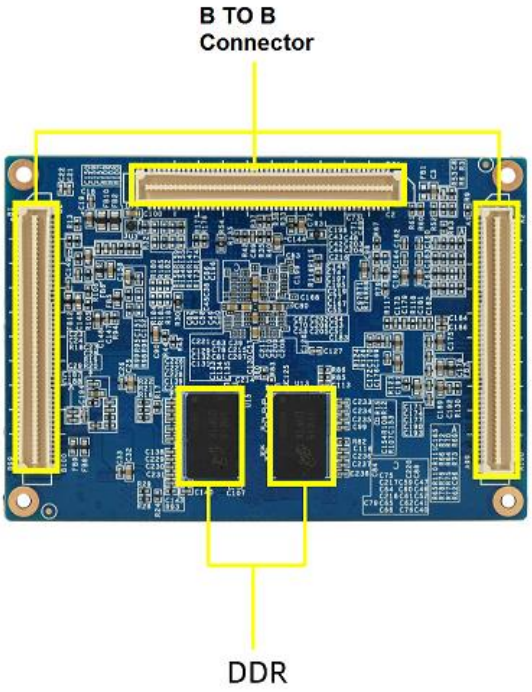
		1*USB HOST (2.0) HSIC
	Ethernet	1*Gigabit Ethernet, by using YT8511 PHY chipset to support RGMII model, self-adaptive for 10M/100M/1000Mbps.
	PWM	4*PWM (*Several PINs can be multiplexed for other signals)
	I2C	3*I2C (*Several PINs can be multiplexed for other signals)
	SPI	5*SPI (*Several PINs can be multiplexed for other signals)
	PCIE	1*PCIE
	CSI	2*CSI DVP Type
	MIPI-CSI2 (Four Channel)	1*MIPI-CSI2 (Four Channel)
	SDIO	1*SDIO
	SATA	1*SATA, supports SATA Ⅱ
	CAN	2* CAN, supports CAN 2.0 protocol. (*Several PINs can be multiplexed for other signals)
	Audio	MIC audio input
		McASP type, Binaural audio output
	EIM	Available
	GPIO	Available
Electronic	Power input	+5V
	Operation temperature	-20℃ ~ +70℃ (Std.) (*-40℃~+85℃ (Opt.))
	Humidity	5%-95%, Non-condensation
Software	OS	Support Android 6.0, Linux 4.1.15
	Data	Provide BSP, DEMO, and testing APK
	Application	Facial recognition, IoT, Intelligent appliances, Advertising machine, POS, Vehicle control terminal

III. Core Board's Picture



TOP Side

Picture 2



Bottom Side

Picture 3

Pin Definition on J1,J2,J3

PIN Definition on J1:

引脚号	默认定义	I/O	引脚号	默认定义	I/O
1	USB_H1_VBUS	/	2	USB_OTG_VBUS	/
3	USB_H1_DP	/	4	USB_OTG_DN	/
5	USB_H1_DN	/	6	USB_OTG_DP	/
7	GPIO_1	GPI01_I001	8	USB_OTG_ID	
9	GPIO_2	GPI01_I002	10	GND	
11	CSI0_HS	GPI05_I019	12	PCIE_CLK_N	/
13	CSI0_VS	GPI05_I021	14	PCIE_CLK_P	/
15	CSI0_PCLK	GPI05_I018	16	GND	/
17	CSI0_PWDN	GPI05_I020	18	PCIE_RXM	/
19	I2C1_SDA	GPI05_I026	20	PCIE_RXP	/
21	I2C1_SCL	GPI05_I027	22	GND	
23	DBG_TXD	GPI05_I028	24	PCIE_TXM	/
25	DBG_RXD	GPI05_I029	26	PCIE_TXP	/
27	CSI0_DAT12	GPI05_I030	28	GND	
29	CSI0_DAT13	GPI05_I031	30	HOTPLUG_DET	/
31	CSI0_DAT14	GPI06_I000	32	HDMI_CEC_IN	/
33	CSI0_DAT15	GPI06_I001	34	GND	
35	CSI0_DAT16	GPI06_I002	36	HDMI_CLKM	/
37	CSI0_DAT17	GPI06_I003	38	HDMI_CLKP	/
39	CSI0_DAT18	GPI06_I004	40	GND	
41	CSI0_DAT19	GPI06_I005	42	HDMI_D0M	/
43	GND		44	HDMI_D0P	/
45	MIC_INP	/	46	GND	
47	MIC_INM	/	48	HDMI_D1M	/
49	LINE_INL	/	50	HDMI_D1P	/
51	LINE_INR	/	52	GND	
53	HPLOUT	/	54	HDMI_D2M	/
55	HPROUT	/	56	HDMI_D2P	/
57	GND		58	GND	
59	UART5_TXD	GPI04_I008	60	UART4_TXD	GPI04_I006
61	UART5_RXD	GPI04_I009	62	UART4_RXD	GPI04_I007
63	CAN2_TXD	GPI04_I014	64	CAN1_TXD	GPI04_I010
65	CAN2_RXD	GPI04_I015	66	CAN1_RXD	GPI04_I011
67	I2C3_SCL	GPI01_I005	68	I2C2_SCL	GPI04_I012
69	I2C3_SDA	GPI01_I006	70	I2C2_SDA	GPI04_I013
71	GND		72	GND	
73	LVDS1_TXN0	/	74	LVDS0_TXN0	/
75	LVDS1_TXP0	/	76	LVDS0_TXP0	
77	GND		78	GND	
79	LVDS1_TXN1	/	80	LVDS0_TXN1	/
81	LVDS1_TXP1	/	82	LVDS0_TXN2	/
83	GND		84	GND	
85	LVDS1_TXN2	/	86	LVDS0_TXN2	/
87	LVDS1_TXP2	/	88	LVDS0_TXP2	/
89	GND		90	GND	
91	LVDS1_CLKN	/	92	LVDS0_CLKN	/
93	LVDS1_CLKP	/	94	LVDS0_CLKP	/
95	GND		96	GND	
97	LVDS1_TXN3	/	98	LVDS0_TXN3	/
99	LVDS1_TXP3	/	100	LVDS0_TXP3	/

PIN Definition on J2:

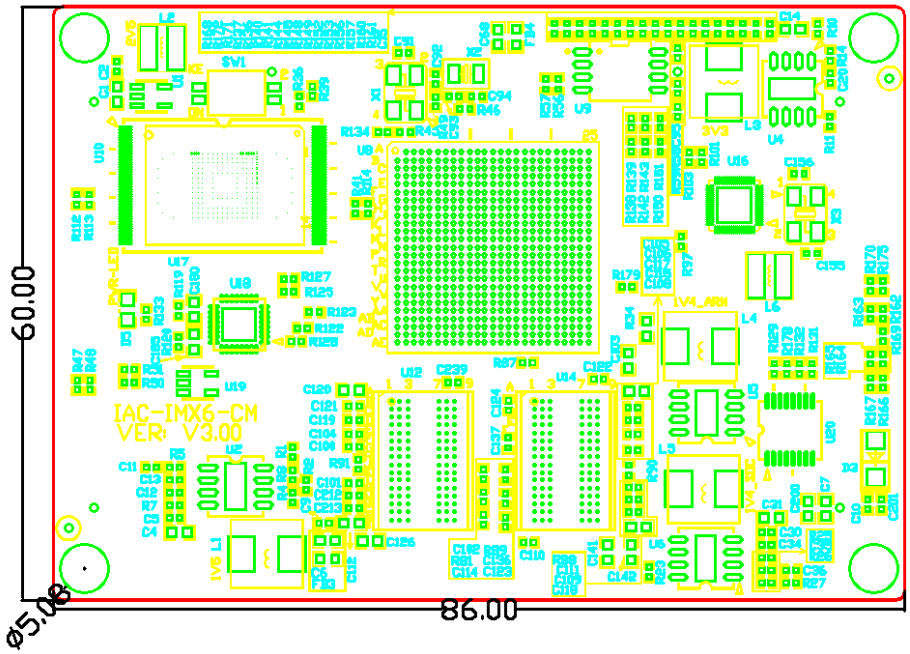
引脚号	默认定义	I/O	引脚号	默认定义	I/O
1	GND	/	2	GND	/
3	GMDN1	/	4	GMDP2	/
5	GMDP1	/	6	GMDN2	/
7	GND	/	8	GND	/
9	GMDN0	/	10	GMDP3	/
11	GMDP0	/	12	GMDN3	/
13	LED_LINK	/	14	LED_ACT	/
15	GND	/	16	GND	/
17	SATA_TXP	/	18	SD2_CLK	GPIO1_IO10
19	SATA_TXM	/	20	SD2_CMD	GPIO1_IO11
21	GND	/	22	SD2_DAT0	GPIO1_IO15
23	SATA_RXM	/	24	SD2_DAT1	GPIO1_IO14
25	SATA_RXP	/	26	SD2_DAT2	GPIO1_IO13
27	GND	/	28	SD2_DAT3	GPIO1_IO12
29	SD3_CLK	GPIO7_IO03	30	SD3_CMD	GPIO7_IO02
31	SD3_DAT0	GPIO7_IO04	32	SD3_DAT4	GPIO7_IO01
33	SD3_DAT1	GPIO7_IO05	34	SD3_DAT5	GPIO7_IO00
35	SD3_DAT2	GPIO7_IO06	36	SD3_DAT6	GPIO6_IO18
37	SD3_DAT3	GPIO7_IO07	38	SD3_DAT7	GPIO6_IO17
39	EIM_OEN	GPIO2_IO25	40	SYS_RSTN	/
41	EIM_WRN	GPIO2_IO26	42	EIM_LBA	GPIO2_IO27
43	EIM_CS1N	GPIO2_IO24	44	EIM_CS0N	GPIO2_IO23
45	EIM_D17	GPIO3_IO17	46	EIM_D16	GPIO3_IO16
47	EIM_D19	GPIO3_IO19	48	EIM_D18	GPIO3_IO18
49	EIM_D21	GPIO3_IO21	50	EIM_D20	GPIO3_IO20
51	EIM_D23	GPIO3_IO23	52	EIM_D22	GPIO3_IO22
53	EIM_D25	GPIO3_IO25	54	EIM_D24	GPIO3_IO24
55	EIM_D27	GPIO3_IO27	56	EIM_D26	GPIO3_IO26
57	EIM_D29	GPIO3_IO29	58	EIM_D28	GPIO3_IO28
59	EIM_D31	GPIO3_IO31	60	EIM_D30	GPIO3_IO30
61	EIM_WAIT	GPIO5_IO00	62	EIM_BCLK	GPIO6_IO31
63	EIM_AD14	GPIO3_IO14	64	EIM_AD13	GPIO3_IO13
65	DISP0_CLK	GPIO4_IO16	66	EIM_AD15	GPIO3_IO15
67	DISP0_VS	GPIO4_IO19	68	DISP0_HS	GPIO4_IO18
69	DISP0_DE	GPIO4_IO17	70	DISP0_CNTRST	GPIO4_IO20
71	DISP0_DAT1	GPIO4_IO22	72	DISP0_DAT0	GPIO4_IO21
73	DISP0_DAT3	GPIO4_IO24	74	DISP0_DAT2	GPIO4_IO23
75	DISP0_DAT5	GPIO4_IO26	76	DISP0_DAT4	GPIO4_IO25
77	DISP0_DAT7	GPIO4_IO28	78	DISP0_DAT6	GPIO4_IO27
79	DISP0_DAT9	GPIO4_IO30	80	DISP0_DAT8	GPIO4_IO29
81	DISP0_DAT11	GPIO4_IO32	82	DISP0_DAT10	GPIO4_IO31
83	DISP0_DAT13	GPIO4_IO34	84	DISP0_DAT12	GPIO4_IO33
85	DISP0_DAT15	GPIO4_IO36	86	DISP0_DAT14	GPIO4_IO35
87	DISP0_DAT17	GPIO4_IO38	88	DISP0_DAT16	GPIO4_IO37
89	TSC_YP	/	90	TSC_XP	/
91	TSC_XM TSC_YM	/	92	TSC_XM	/
93	GND	/	94	GND	/
95	GND	/	96	GND	/
97	GND	/	98	GND	/
99	GND	/	100	GND	/

PIN Definition on J3:

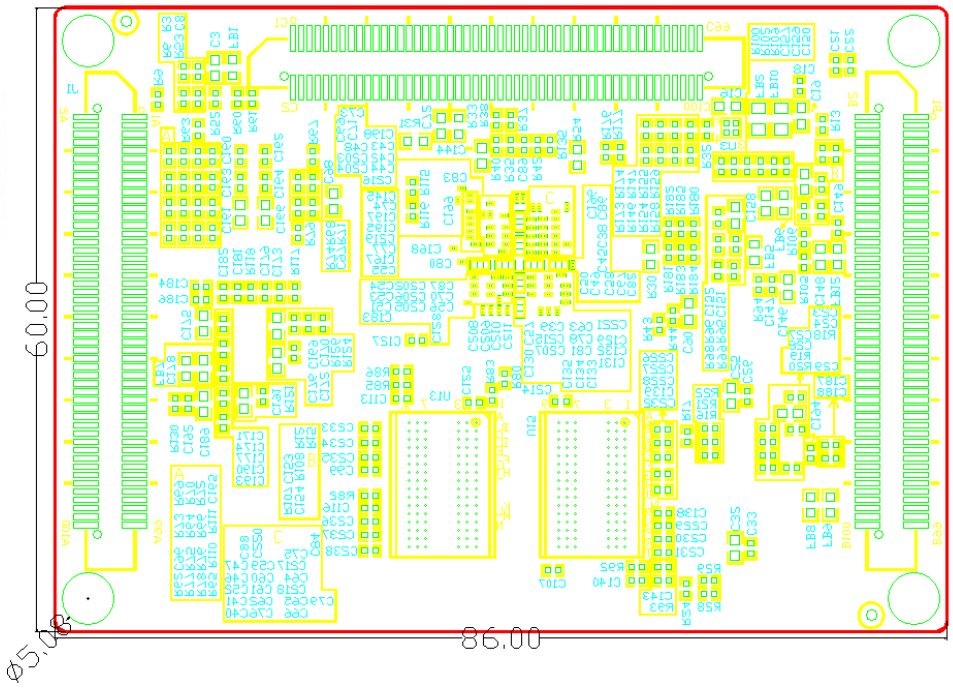
引脚号	默认定义	I/O	引脚号	默认定义	I/O
1	GND	/	2	GND	/
3	DSI_CLK0M	/	4	JTAG_TCK	/
5	DSI_CLK0P	/	6	JTAG_TMS	/
7	GND	/	8	JTAG_TDI	/
9	DSI_D0M	/	10	JTAG_TDO	/
11	DSI_D0P	/	12	JTAG_TRSTN	/
13	GND	/	14	GND	/
15	DSI_D1M	/	16	GND	/
17	DSI_D1P	/	18	GND	/
19	GND	/	20	GPIO_4	GPIO1_IO04
21	CSI_D0M	/	22	GPIO_7	GPIO1_IO07
23	CSI_D0P	/	24	GPIO_8	GPIO1_IO08
25	GND	/	26	GPIO_9	GPIO1_IO09
27	CSI_D1M	/	28	GND	/
29	CSI_D1P	/	30	GPIO_16	GPIO7_IO11
31	GND	/	32	GPIO_17	GPIO7_IO12
33	CSI_D2M	/	34	GPIO_18	GPIO7_IO13
35	CSI_D2P	/	36	GPIO_19	GPIO4_IO05
37	GND	/	38	GND	/
39	CSI_D3M	/	40	GND	/
41	CSI_D3P	/	42	GND	/
43	GND	/	44	ON/OFF	/
45	CSI_CLK0M	/	46	GND	/
47	CSI_CLK0P	/	48	GND	/
49	GND	/	50	GND	/
51	GND	/	52	GND	/
53	MLB_SP	/	54	GND	/
55	MLB_SN	/	56	GND	/
57	GND	/	58	GND	/
59	MLB_DP	/	60	GND	/
61	MLB_DN	/	62	GND	/
63	GND	/	64	GND	/
65	MLB_CP	/	66	GND	/
67	MLB_CN	/	68	GND	/
69	GND	/	70	GND	/
71			72	GND	/
73	GND	/	74	GND	/
75	CSI1_D13	GPIO2_IO20	76	CSI1_PCLK	GPIO2_IO22
77	CSI1_D15	GPIO2_IO18	78	CSI1_D12	GPIO2_IO21
79	CSI1_D17	GPIO2_IO16	80	CSI1_D14	GPIO2_IO19
81	CSI1_D19	GPIO5_IO04	82	CSI1_D16	GPIO2_IO17
83	CSI1_D11	GPIO2_IO28	84	CSI1_D18	GPIO6_IO06
85	CSI1_D9	GPIO3_IO00	86	CSI1_D10	GPIO2_IO29
87	CSI1_D7	GPIO3_IO02	88	CSI1_D8	GPIO3_IO01
89	CSI1_D5	GPIO3_IO04	90	CSI1_D6	GPIO3_IO03
91	CSI1_D3	GPIO3_IO06	92	CSI1_D4	GPIO3_IO05
93	CSI1_D1	GPIO3_IO08	94	CSI1_D2	GPIO3_IO07
95	CSI1_DEN	GPIO3_IO10	96	CSI1_D0	GPIO3_IO09
97	CSI1_VS	GPIO3_IO12	98	CSI1_HS	GPIO3_IO11
99	GND	/	100	GND	/

Ⅳ. Size & Structure

Top- Layer



Bottom -Layer



V. Environment Test

High & Low Temperature Test : -20°C~70°C

1.1 试验标准 Test Criterion

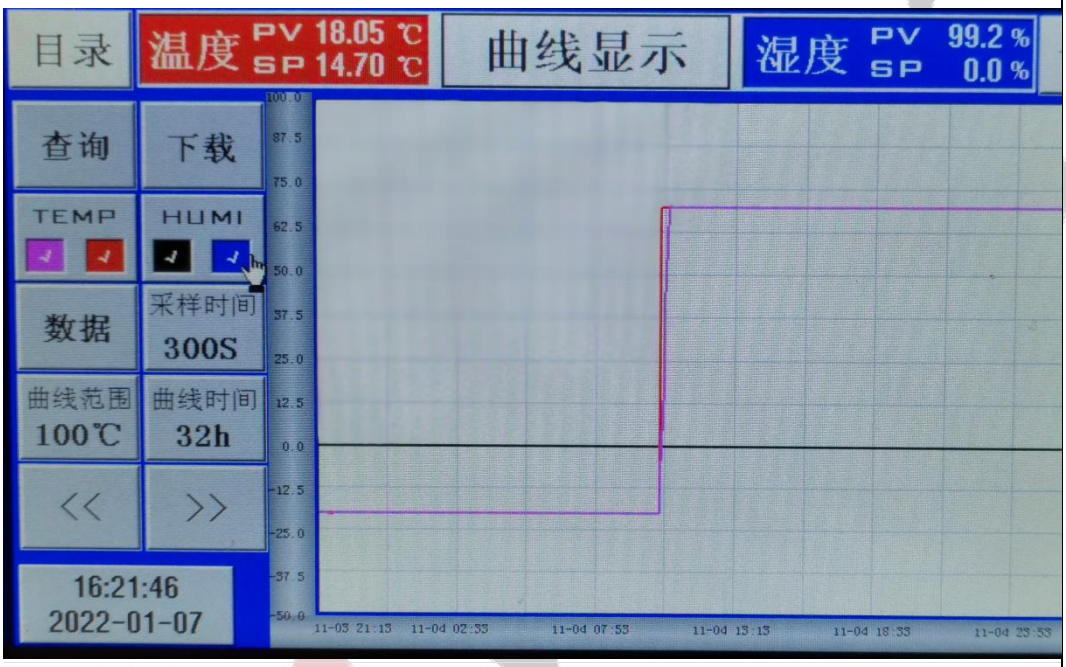
试验项目	采用标准	试验结果
低温试验 Low Temperature Test	GB/T2423.1-2008	☑PASS ☐FAIL
高温试验 High Temperature Test	GB/T2423.2-2008	☑PASS ☐FAIL
恒定湿热试验 Steady-state damp heat test	GB/T2423.3-2006	☐PASS ☐FAIL
交变湿热试验 Cyclic damp heat test	GB/T2423.4-2008	☐PASS ☐FAIL
温度循环试验 Temperature cycle test	GB/T2423.22-2012	☐PASS ☐FAIL
振动（正弦）试验 Vibration (Sine)Test	GB/T2423.10-2008	☐PASS ☐FAIL
自由跌落试验 Drop Test	GB/T2423.8-1995 ISTA 2A-2006	☐PASS ☐FAIL

1.2 试验仪器 Test Instrument

试验项目 Item	试验仪器 Test Instrument	型号 Model No.	生产厂家 Manufacturer
低温试验 Low Temperature Test	高低温（湿热）试验箱 High and low temperature (Damp Heat) test chamber	SMC-225PF	东莞市皓天实验设备有限公司 Dongguan HAOTIAN Testing Equipment Co., Ltd.
高温试验 High Temperature Test			

Environment Compatibility Verification Test

Temp./Humidity	25℃	Temp. Range	-20℃ ＋70℃
Experiment Period	32H	Test Engineer	Yangw
Performance Requirement	A		
Line Chart as below:			

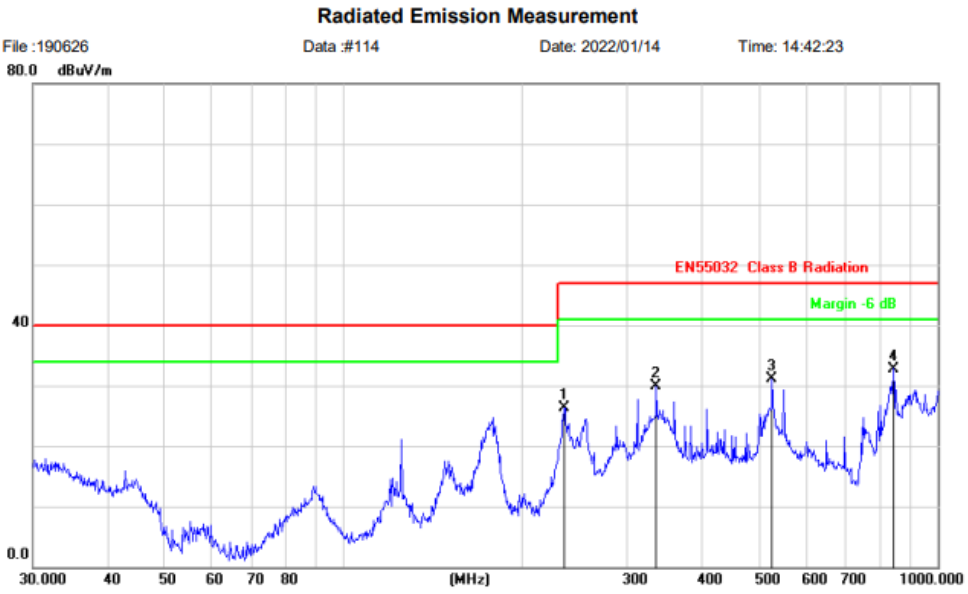


Real-time Monitoring Curved Line

Result:	☑ PASS	☐ FAIL

Ⅵ.EMC Test:

Radiated Emission Test Result



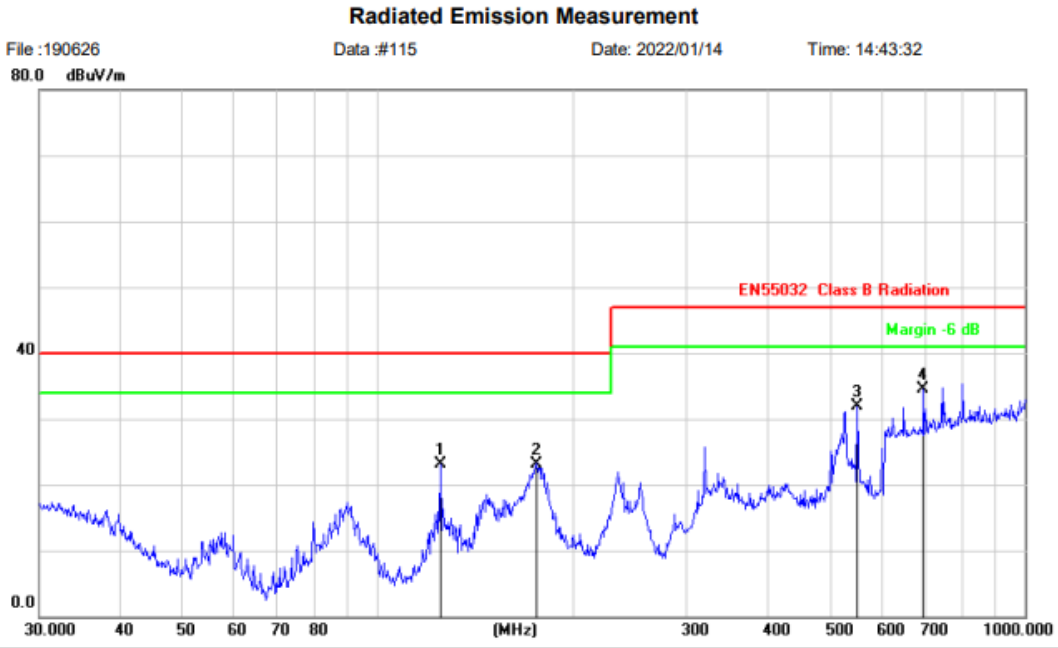
Site LAB
Limit: EN55032 Class B Radiation
EUT:
M/N:
Mode:
Note: IAC-IMX6D-CM-V2.06

Polarization: *Horizontal*
Power:
Distance: 3m

Temperature:
Humidity: %

No.	Mk.	Freq.	Reading Level	Correct Factor	Measure-ment	Limit	Over		Antenna Height	Table Degree	
		MHz	dBuV	dB	dBuV/m	dB/m	dB	Detector	cm	degree	Comment
1		234.9909	34.94	-8.56	26.38	47.00	-20.62	peak			
2		336.0351	38.51	-8.56	29.95	47.00	-17.05	peak			
3		526.3967	32.49	-1.44	31.05	47.00	-15.95	peak			
4	*	842.1295	10.00	22.80	32.80	47.00	-14.20	peak			

Radiation Test Result: Horizontal Polarization Direction



Site LAB
Limit: EN55032 Class B Radiation
EUT:
M/N:
Mode:
Note: IAC-IMX6D-CM-V2.06

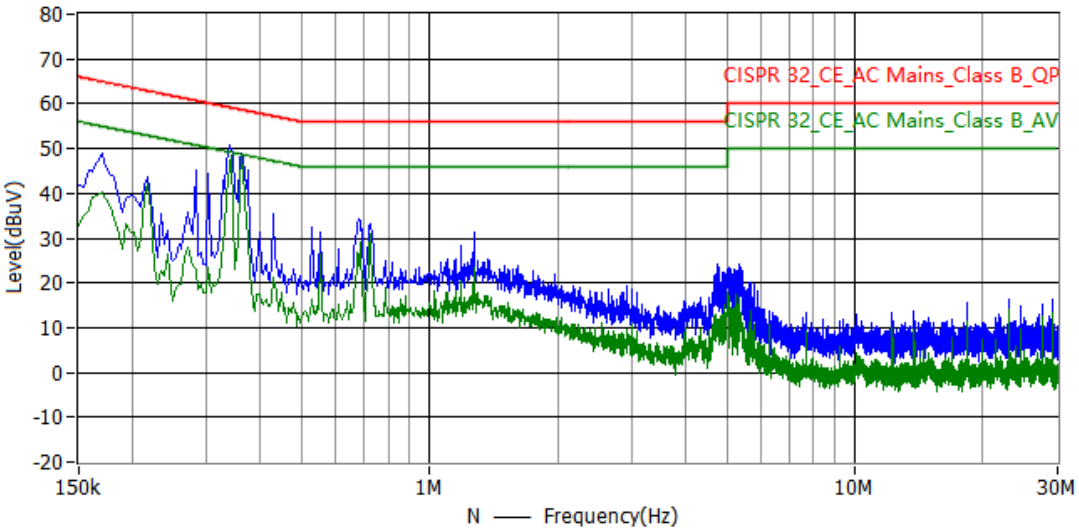
Polarization: *Vertical*
Power:
Distance: 3m

Temperature:
Humidity: %

No.	Mk.	Freq.	Reading Level	Correct Factor	Measure-ment	Limit	Over		Antenna Height	Table Degree	
		MHz	dBuV	dB	dBuV/m	dB/m	dB	Detector	cm	degree	Comment
1		125.0066	40.96	-17.95	23.01	40.00	-16.99	peak			
2		176.2685	33.91	-10.71	23.20	40.00	-16.80	peak			
3		550.9479	38.05	-6.08	31.97	47.00	-15.03	peak			
4	*	696.8567	11.94	22.65	34.59	47.00	-12.41	peak			

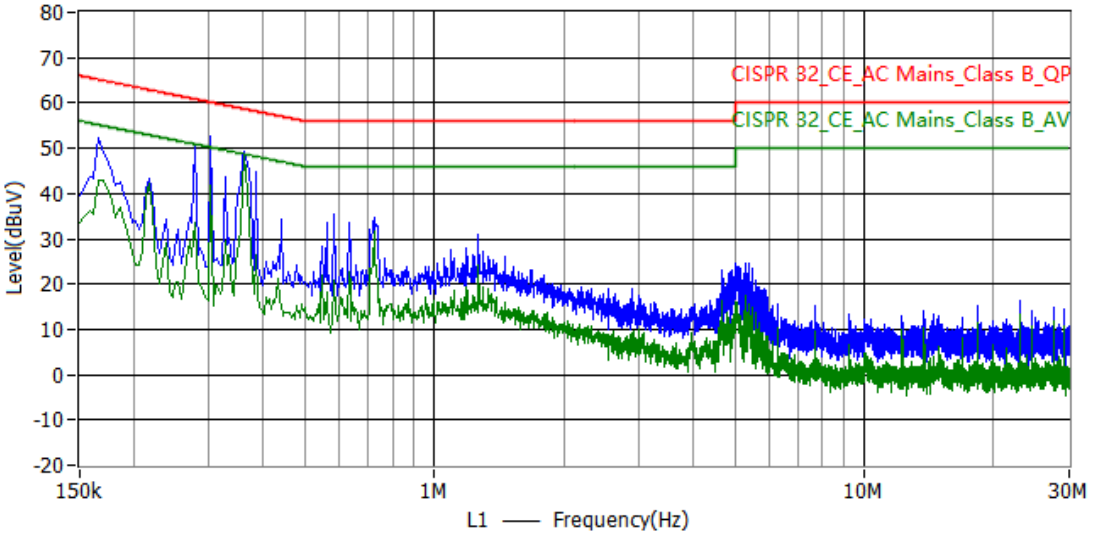
Radiation Test Result: Vertical Polarization Direction

Conductivity Test



No.	Frequency	Limit dBuV	Level dBuV	Margin dB	Factor dB	Detector	Phase
1*	170.000 kHz	65.0	48.9	-16.1	10.1	PK	N
2*	218.000 kHz	62.9	43.7	-19.1	10.0	PK	N
3*	282.000 kHz	60.8	45.2	-15.5	10.0	PK	N
4*	338.000 kHz	59.3	50.8	-8.5	10.0	PK	N
5*	374.000 kHz	58.4	45.2	-13.2	10.0	PK	N
6*	682.000 kHz	56.0	34.2	-21.8	9.9	PK	N
7*	170.000 kHz	55.0	40.3	-14.6	10.1	AV	N
8*	194.000 kHz	53.9	33.2	-20.7	10.0	AV	N
9*	218.000 kHz	52.9	42.3	-10.6	10.0	AV	N
10*	362.000 kHz	48.7	48.0	-0.7	10.0	AV	N
11*	554.000 kHz	46.0	26.3	-19.7	10.0	AV	N
12*	726.000 kHz	46.0	30.8	-15.2	9.9	AV	N

Conductivity Test Result: Negative- IAC-IMX6-CM V3.01



No.	Frequency	Limit dBuV	Level dBuV	Margin dB	Factor dB	Detector	Phase
1*	166.000 kHz	65.2	52.2	-13.0	10.1	PK	L1
2*	218.000 kHz	62.9	43.4	-19.5	9.8	PK	L1
3*	302.000 kHz	60.2	52.8	-7.4	9.9	PK	L1
4*	362.000 kHz	58.7	49.3	-9.4	10.0	PK	L1
5*	586.000 kHz	56.0	35.5	-20.5	10.0	PK	L1
6*	726.000 kHz	56.0	34.5	-21.5	10.0	PK	L1
7*	170.000 kHz	55.0	43.0	-11.9	10.1	AV	L1
8*	218.000 kHz	52.9	42.3	-10.6	9.8	AV	L1
9*	270.000 kHz	51.1	29.4	-21.7	9.9	AV	L1
10*	302.000 kHz	50.2	41.7	-8.5	9.9	AV	L1
11*	362.000 kHz	48.7	48.2	-0.4	10.0	AV	L1
12*	726.000 kHz	46.0	31.7	-14.3	10.0	AV	L1

Conductivity Test Result: Positive- IAC-IMX6-CM V3.01

Ⅶ. Software Description

IAC-IMX6-CM provides the software support for Android OS &Linux OS

The ***IAC-I.MX6-Kit User Manual*** will introduce the IAC-I.MX6-KIT mainboard's setting up and using in Android/Linux developing environment. The detailed content could refer to the relative documentation.

Ⅷ. Remark

1. Before connecting to LCD, please confirm the power specification of LCD module.
2. Please use the original connecting accessories to avoid damaging the main board.
3. We ensure offering communication technology support through E-mail, telephone for lifelong technical support service.
4. We ensure offering 6 months repair service for free, if malfunction occurs in warranty because of quality problem, contact our retailer or our company with purchase receipt in warranty period, we will repair or replace it.
5. Under these circumstances, we do not offer repair for free:

- Over warranty time;
- Do not have purchase receipt;
- Liquid inlet, Damp or Mold;
- Malfunction and damage is not due to product quality but drops, intense sharking, arbitrarily modify, disoperation after purchase;
- Damage of force majeure.

6. We reserve intellectual property for the software and hardware technical data of IAC-IMX6-KIT; users can only use them for teaching, testing, researching. Shall not be engaged in any commercial purpose. Shall not distribute them on the Internet. Shall not intercept, modify them to tamper copyright.
7. We accept batch order; we can offer comprehensive technical support and service.

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